



NOTES:

- 1) R16 for test purposes only
- 2) built on PCB PMP8673 RevA
- 3) Vin < 4.5V needs external bias

Assembly:

- 1) C9, C15, C23, R2 does not meet pattern
- 2) ref des >100 placed externally

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Project Title: Sync Boost w/ LM5121	Mod. Date: 9/23/2015	 http://www.ti.com
Number: PMP10092 Rev: A	Sheet Title: 1 Ch Boost Converter	
Version: Version control disabled	Assembly Variant: [No Variations]	
Drawn By: [Redacted]	File: PMP10092RevA.SchDoc	
Engineer: B.Geck	Contact: http://www.ti.com/support	Sheet: 1 of 1 Size: B

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